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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date	
David J Frank	02/23/2007	
Douglas C La Tulipe, Jr.	02/23/2007	
Leathen Shi	03/02/2007	
Steven E Steen	02/23/2007	
Anna W Topol	02/23/2007	

RECEIVING PARTY DATA

Name:	International Business Machines Corporation	
Street Address:	New Orchard Road	
City:	Armonk	
State/Country:	NEW YORK	
Postal Code:	10504	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11682638

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ATTORNEY DOCKET NUMBER:	YOR920060191US1 (19740)	
NAME OF SUBMITTER:	Leslie S. Szivos	

PATENT REEL: 018999 FRAME: 0273

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Total Attachments: 2 source=YOR920060191US1_Assignment#page1.tif source=YOR920060191US1_Assignment#page2.tif

PATENT REEL: 018999 FRAME: 0274

IBM Docket No.: YOR920060191US1

SSMP: 19740

ASSIGNMENT

Whereas, we

Inventor and City (1) David J. Frank County of Westchester City of Yorktown Heights and State of New York

and

(2) Douglas C. La Tuilpe, Jr. County of Fairfield

City of New Fairfield and State of Connecticut

and

(3) Leathen Shi **County of Westchester** City of Yorktown Heights and State of New York

and

(4) Steven E. Steen **County of Westchester** City of Peekskiil

and State of New York

and

(5) Anna W. Topol **County of Westchester** City of Jefferson Valley and State of New York

have invented certain improvements in

Title

METHOD FOR PREPARING 2-DIMENSIONAL SEMICONDUCTOR DEVICES FOR INTEGRATION IN A THIRD DIMENSION

Dates That inventors Signed the Declaration and have executed, respectively, a United States patent application therefor on

February 23, 3/2/07 25 (3)

February 23,

2007, and

2007, and (2) 2007, and (4)

2/27/07 8 2007, and

(5)2123/07

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor:

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we the above named hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to Issue any Letters Patent granted upon the invention set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

PAGE 1 OF 2

IBM Docket No.: YOR920060191US1

SSMP: 19740

ASSIGNMENT

City	(1) Signed at	σ .	100		
Date	on 2/23/07	(David First Name	J. Middle initial	Frank) Last Name	signature inventor
City	(2) Signed at	-D 1	. 2 2		
Date	on 2/23/07	(Douglas) First Name	C. Middle Initial	Lal Vulipe, Jr. Last Name	elgnature) inventor
City	(3) Signed at Yorktown Heights, NY				
Date	on 3/2/07	(Leathen First Name	Middle Initial	Shi) Last Name	signature Inventor
City	(4) Signed at				
Date	on 2/23/07	(Steven First Name	E. Middle Initial	Steen) Last Name	signature Inventor
City	(5) Signed at	1	- al		
Date	on 2/23/07	(Anna First Name	W. Middle Initial	Topol) Last Name	signature Inventor

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